

HI-8596

Single-Rail ARINC 429 Differential Line Driver

July 2011

GENERAL DESCRIPTION

The HI-8596 bus interface product is a silicon gate CMOS device designed as a line driver in accordance with the ARINC 429 bus specifications. The part includes a dual polarity voltage doubler, allowing it to operate from a single +3.3V supply using only four external capacitors. The part also features high-impedance outputs (tri-state) when both data inputs are taken high, allowing multiple line drivers to be connected to a common bus.

Logic inputs feature built-in 4kV ESD input protection (HBM) as well as 5V or 3.3V logic level compatibility.

37.5 Ohm or 5 Ohm resistors in series with each ARINC output are available to allow the use of external resistors for lightning protection.

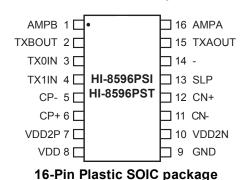
The HI-8596 line driver is intended for use where logic signals must be converted to ARINC 429 levels such as when using an FPGA or the HI-3586 ARINC 429 protocol IC.

The part is available in Industrial -40°C to +85°C, or Extended, -55°C to +125°C temperature ranges. Optional burn-in is available on the extended temperature range.

FEATURES

- · Single +3.3V supply
- · All ARINC 429 voltage levels generated on-chip
- · Digitally selectable rise and fall times
- · Tri-state Outputs
- 5 Ohm or 37.5 Ohm output resistance
- · Industrial and Extended temperature ranges
- Burn-in available

PIN CONFIGURATION (TOP VIEW)



(See page 9 for additional package pin configurations)

(Narrow Body)

Table 1. Function Table

TX1IN	TX0IN	SLP	TXAOUT	TXBOUT	SLOPE
0	0	Х	0V	0V	N/A
0	1	0	-5V	5V	10µs
0	1	1	-5V	5V	1.5µs
1	0	0	5V	-5V	10µs
1	0	1	5V	-5V	1.5µs
1	1	Х	Hi-Z	Hi-Z	N/A

BLOCK DIAGRAM

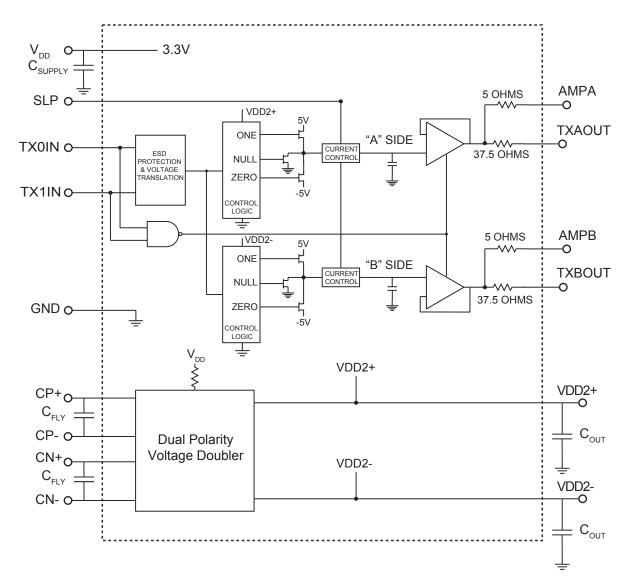


Figure 1. HI-8596 Block Diagram

HI-8596

PIN DESCRIPTIONS

Table 2. Pin Descriptions

Pin	Function	Description
SLP	INPUT	Output slew rate control. High selects ARINC 429 high-speed. Low selects ARINC 429 low-speed.
TX0IN	INPUT	Data input zero
TX1IN	INPUT	Data input one
V_{DD}	POWER	+3.3V power supply
GND	POWER	Ground supply
V _{DD2+}	OUTPUT	Voltage doubler positive output (~6.6V for 3.3V supply)
CP+	ANALOG	$V_{\tiny{DD2+}}$ flyback capacitor, $C_{\tiny{FLY}}$; positive terminal
CP-	ANALOG	$V_{\tiny{DD2+}}$ flyback capacitor, $C_{\tiny{FLY}}$; negative terminal
$V_{_{\mathrm{DD2}}}$	OUTPUT	Voltage doubler negative output (~ -6.6V for 3.3V supply)
CN+	ANALOG	$V_{\tiny{DD2-}}$ flyback capacitor, $C_{\tiny{FLY}}$; positive terminal
CN-	ANALOG	$V_{\tiny{DD2-}}$ flyback capacitor, $C_{\tiny{FLY}}$; negative terminal
TXAOUT	OUTPUT	ARINC high output with 37.5 Ohms series resistance
AMPA	OUTPUT	ARINC high output with 5 Ohms series resistance
TXBOUT	OUTPUT	ARINC low output with 37.5 Ohms series resistance
AMPB	OUTPUT	ARINC low output with 5 Ohms series resistance

FUNCTIONAL DESCRIPTION

Figure 1 is a block diagram of the line driver. The HI-8596 requires only a single +3.3V power supply. An integrated inverting / non-inverting voltage doubler generates the rail voltages (±6.6V) which are then used to produce the ±5V ARINC-429 output levels.

The internal dual polarity charge pump circuit requires four external capacitors, two for each polarity generated by the doubler. CP+ and CP- connect the external charge transfer or "fly" capacitor, $C_{\rm FLY}$, to the positive portion of the doubler, resulting in twice $V_{\rm DD}$ at the $V_{\rm DD2+}$ pin. An output "hold" capacitor, $C_{\rm OUT}$, is placed between $V_{\rm DD2+}$ and GND. $C_{\rm OUT}$ should be ten times the size of $C_{\rm FLY}$. The inverting or negative portion of the converter works in a similar fashion, with $C_{\rm FLY}$ and $C_{\rm OUT}$ placed between CN+ / CN- and $V_{\rm DD2-}$ / GND respectively.

Currents for slope control are set by on-chip resistors.

The TX0IN and TX1IN inputs receive logic signals from a control transmitter chip such as the HI-3584. TXAOUT and TXBOUT hold each side of the ARINC bus at Ground until one of the inputs becomes a One. If for example TX1IN goes high, a charging path is enabled to

5V on an "A" side internal capacitor while the "B" side is enabled to -5V. The charging current is selected by the SLP pin. If the SLP pin is high, the capacitor is nominally charged from 10% to 90% in 1.5μs. If SLP is low, the rise and fall times are 10μs.

A unity gain buffer receives the internally generated slopes and differentially drives the ARINC line. Current is limited by the series output resistors at each pin. There are no fuses at the outputs of the HI-8596.

The HI-8596 has 37.5 ohms in series with each TXOUT output and 5 ohms in series with each AMP output. The AMP outputs are for applications where external series resistance is required, typically for lightning protection devices. Holt Application Note AN-300 describes suitable lightning protection schemes.

Tri-stateable outputs allow multiple line drivers to be connected to the same ARINC 429 bus. Setting TX1IN and TX0IN both to a logic "1" puts the outputs in the high-impedance state.

ABSOLUTE MAXIMUM RATINGS

Supply Voltages
V _{DD} +5V
Power Dissipation at 25°C
plastic SOIC 1.0W, derate 10mW/°C
ceramic DIP 0.5W, derate 7mW/°C
Solder Temperature
Storage Temperature65°C to +150°C

Note: HEAT SINK on QFN PACKAGE

The HI-8596 driver is available in a small-footprint, thermally enhanced QFN (chip-scale) package. This package includes an electrically isolated metal heat sink located on the bottom surface of the device. This heat sink should be soldered down to the printed circuit board for optimum thermal dissipation.

RECOMMENDED OPERATING CONDITIONS

- 6	
	Supply Voltages
	V _{DD} +3.0V to +3.6V
	Temperature Range
	Industrial Screening40°C to +85°C
	Hi-Temp Screening55°C to +125°C

NOTE: Stresses above absolute maximum ratings or outside recommended operating conditions may cause permanent damage to the device. These are stress ratings only. Operation at the limits is not recommended.

ELECTRICAL CHARACTERISTICS

Table 3. DC Electrical Characteristics

 $V_{\rm DD}$ = +3.3V, $T_{\rm A}$ = Operating Temperature Range (unless otherwise stated)

Parameters	Symbol	Test Conditions	Min	Тур	Max	Units
Input Voltage (TX1IN, TX0IN, SLP)						
High	V _{IH}		0.7V _{DD}	-	-	V
Low	V _{IL}		-	-	0.3V _{DD}	V
Input Current (TX1IN, TX0IN, SLP)						
Source	I _{IH}	$V_{IN} = 0V$	-	-	0.1	μΑ
Sink	I _{IL}	V_{IN} = 3.3V, 7.34k Ω pulldown	-	45		μΑ
ARINC Output Voltage (Differential)						
one	V_{DIFF1}	no load; TXAOUT - TXBOUT	9	10	11	V
zero	V _{DIFF0}	no load; TXAOUT - TXBOUT	-11	-10	-9	V
null	$V_{\scriptscriptstyle DIFFN}$	no load; TXAOUT - TXBOUT	-0.5	0	0.5	V
ARINC Output Voltage (Ref. to GND)						
one or zero	V _{DOUT}	no load & magnitude at pin	4.5	5.0	5.5	V
null	V _{NOUT}	no load	-0.25	0	0.25	V
Operating Supply Current		SLP = V _{DD}				
No load	I _{DDNL}	TX1IN & TX0IN = 0V	-	28	40	mA
Max. Load	I _{DDL}	100kHz, 400Ω load	-	65	-	mA
ARINC Output Impedance	Z _{out}					
TXOUT pins				37.5		Ohms
AMP pins				5		Ohms
ARINC Output Tri-State Current	I _{oz}	TX0IN = TX1IN = V _{DD}	-1.0	0	+1.0	μΑ
	OZ	-5.75V < V _{OUT} < +5.75V				Par. 1

Table 4. Converter Characteristics

 $V_{\tiny DD}$ = +3.3V, $T_{\tiny A}$ = Operating Temperature Range (unless otherwise stated)

Parameters	Symbol	Test Conditions	Min	Тур	Max	Units
Start-up transient (V+, V-)	t _{START}		-	-	10	ms
Operating Switching Frequency	f _{sw}		-	650	-	kHz
	C_{FLY}	C _{OUT} / C _{FLY} >= 10	2.2	4.7	-	μF
Recommended Capacitors	C _{OUT}		22	47	-	μF
- toooou capacitorio	C _{SUPPLY}	$C_{SUPPLY} >= C_{OUT}$ (connect from V_{DD} to GND)	47	68	-	μF

Table 5. AC Electrical Characteristics

 $V_{\rm DD}$ = +3.3V, $T_{\rm A}$ = Operating Temperature Range (unless otherwise stated)

Parameters	Symbol	Test Conditions	Min	Тур	Max	Units
Line Driver Propogation Delay		defined in Figure 2, no load				
Output high to low	t _{phlx}		-	500	-	ns
Output low to high	t _{plhx}		-	500	-	ns
Line Driver Transition Times						
High Speed		SLP = V+				
Output high to low	t _{fx}	pin 1 = logic 1	1.0	1.5	2.0	μs
Output low to high	t _{rx}	pin 1 = logic 1	1.0	1.5	2.0	μs
Low Speed		SLP = V+				
Output high to low	t _{fx}	pin 1 = logic 0	5.0	10.0	15.0	μs
Output low to high	t _{rx}	pin 1 = logic 0	5.0	10.0	15.0	μs
Input Capacitance (Logic) ¹	C _{IN}		-	-	10	pF
Output Capacitance (Tri-state) ¹ C _{OUT}		TX0IN = TX1IN = V _{DD}	-	-	10	pF

Notes:

1. Guaranteed but not tested

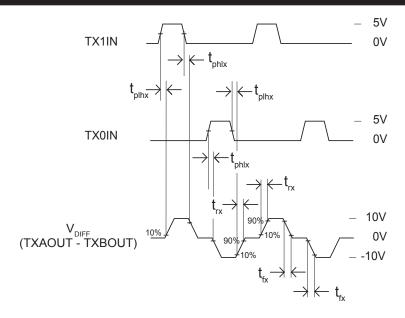


Figure 2. Line Driver Timing

ORDERING INFORMATION

HI - 8596<u>Px x x</u> (Plastic)

PART NUMBER	LEAD FINISH			
Blank	Tin / Lead (Sn / Pb) Solder			
F	100% Matte Tin (Pb-free, RoHS compliant)			

PART NUMBER	TEMPERATURE RANGE	FLOW	BURN IN
I	-40°C to +85°C	1	No
Т	-55°C to +125°C	Т	No
M	-55°C to +125°C	М	Yes

PART NUMBER	PACKAGE DESCRIPTION	LEAD FINISH
8596PS	16 PIN PLASTIC SMALL OUTLINE - NB SOIC (16HN)	Solder
8596PC	16 PIN PLASTIC QFN (16PCS)	Solder

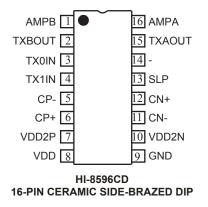
HI - 8596<u>CD x</u> (Ceramic)

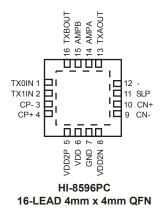
PART NUMBER	TEMPERATURE RANGE	FLOW	BURN IN	LEAD FINISH
I	-40°C to +85°C	I	No	Gold (Pb-free, RoHS compliant)
Т	-55°C to +125°C	Т	No	Gold (Pb-free, RoHS compliant)
М	-55°C to +125°C	М	Yes	Tin / Lead (Sn / Pb) Solder

PART NUMBER	PACKAGE DESCRIPTION
8596CD	20 PIN CERAMIC SIDE BRAISED DIP (20C)

ADDITIONAL PIN CONFIGURATIONS

NOTE: All power and ground pins <u>must</u> be connected.



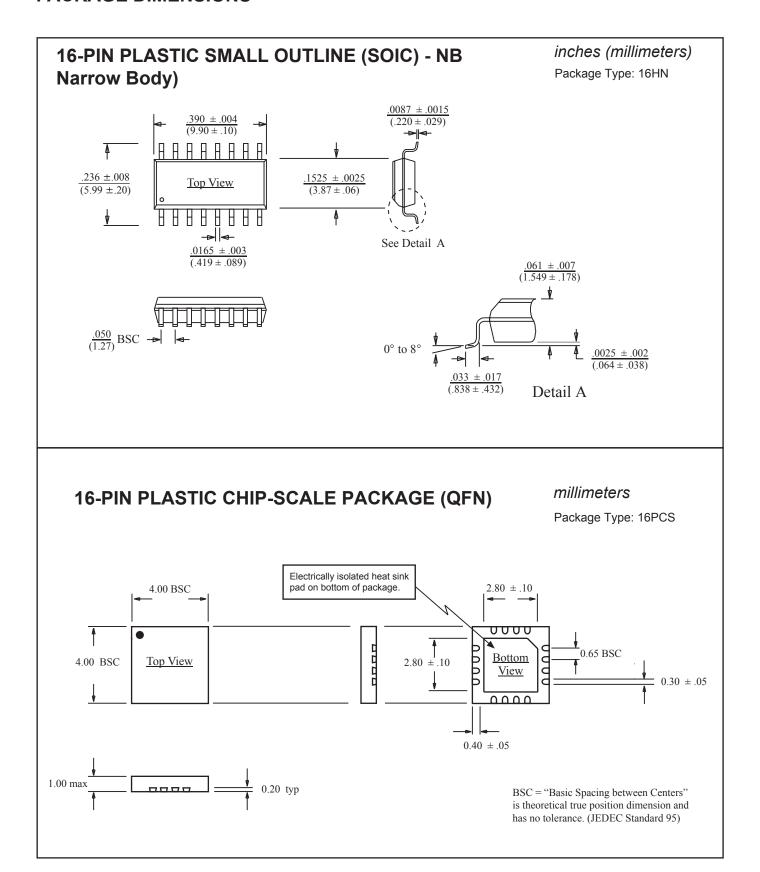


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REVISION HISTORY

Revision		Date	Description of Change
DS8596,	Rev. NEW	11/10/10	Initial Release
	Rev. A	11/11/10	Clarified connection of heat sink and updated some electrical parameters (V_{IH}, V_{IL}, f_{sw}) . Added operating supply current at full load (I_{DDL}) .
	Rev. B	7/14/11	Updated supply voltage range. Corrected dimensions on QFN heat sink. Added voltage limits for Tri-state output current.

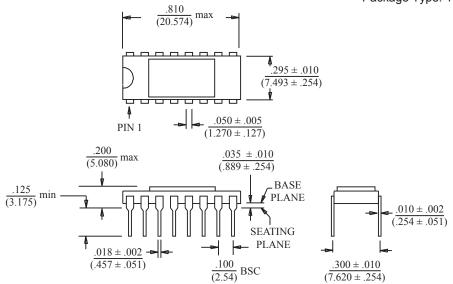
PACKAGE DIMENSIONS



16-PIN CERAMIC SIDE-BRAZED DIP

inches (millimeters)

Package Type: 16C



BSC = "Basic Spacing between Centers" is theoretical true position dimension and has no tolerance. (JEDEC Standard 95)